

Part Number: L-59CB/1EYW

High Efficiency Red
Yellow

Features

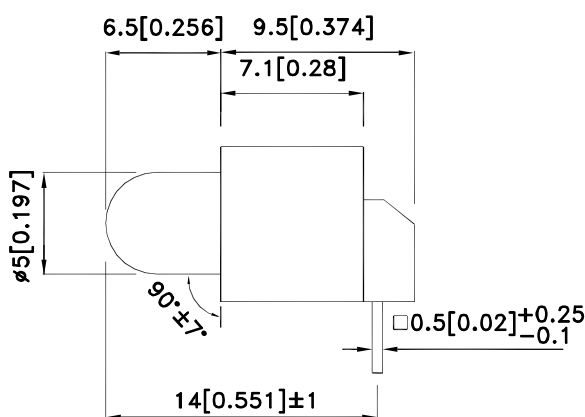
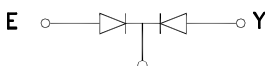
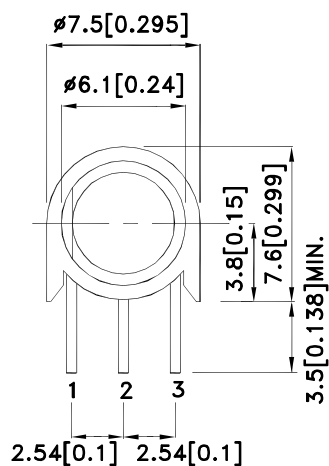
- Pre-trimmed leads for pc board mounting.
- 3 leads with common lead.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability - life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



- 1 ANODE RED
- 2 COMMON CATHODE
- 3 ANODE YELLOW

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
L-59CB/1EYW	High Efficiency Red (GaAsP/GaP)	White Diffused	30	60	60°
	Yellow (GaAsP/GaP)		*20	*40	
			20	40	
			*20	*40	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Yellow	627 590		nm	IF=20mA
λD [1]	Dominant Wavelength	High Efficiency Red Yellow	617 588		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Yellow	45 35		nm	IF=20mA
C	Capacitance	High Efficiency Red Yellow	15 20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red Yellow	2 2.1	2.5 2.5	V	IF=20mA
IR	Reverse Current	High Efficiency Red Yellow		10 10	uA	VR = 5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

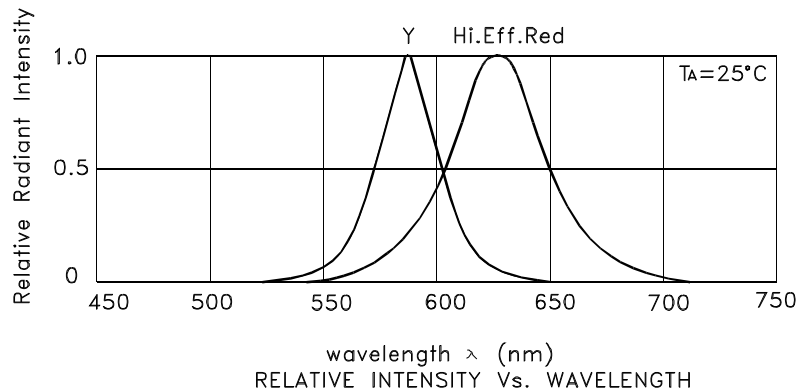
Parameter	High Efficiency Red	Yellow	Units
Power dissipation	75	75	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	160	140	mA
Reverse Voltage	5		V
Operating / Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

Notes:

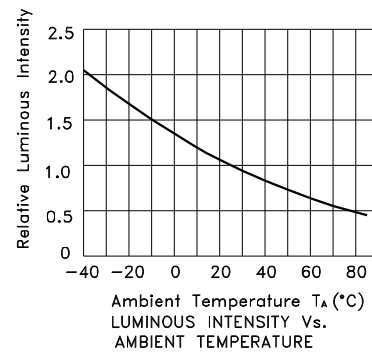
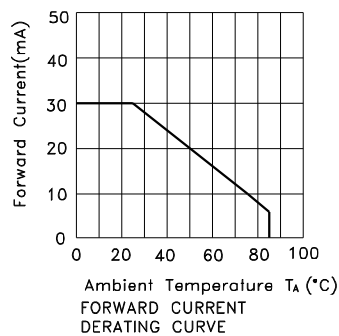
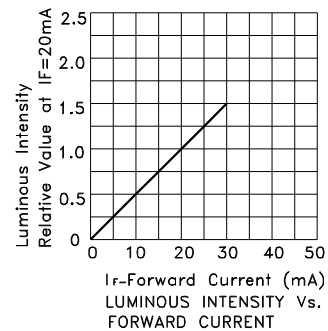
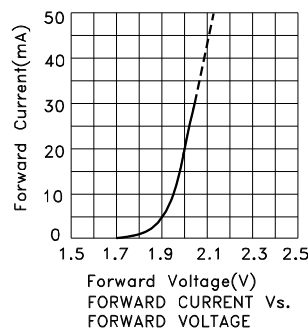
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

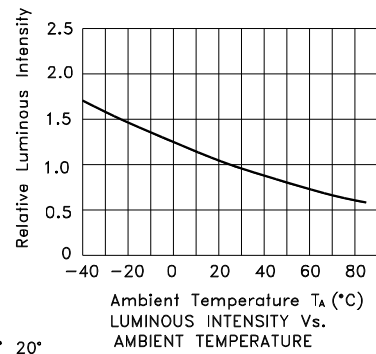
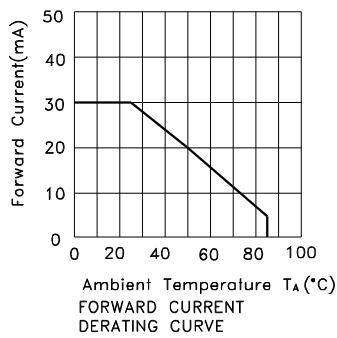
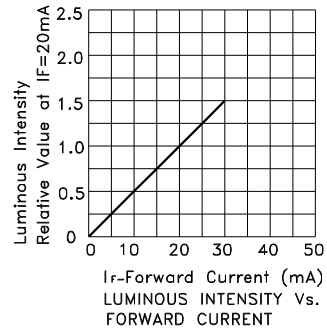
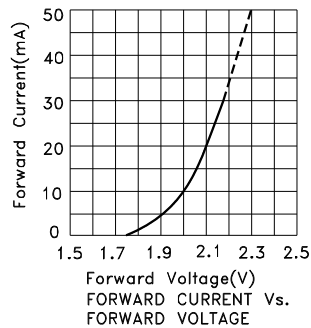
3. 5mm below package base.



L-59CB/1EYW High Efficiency Red

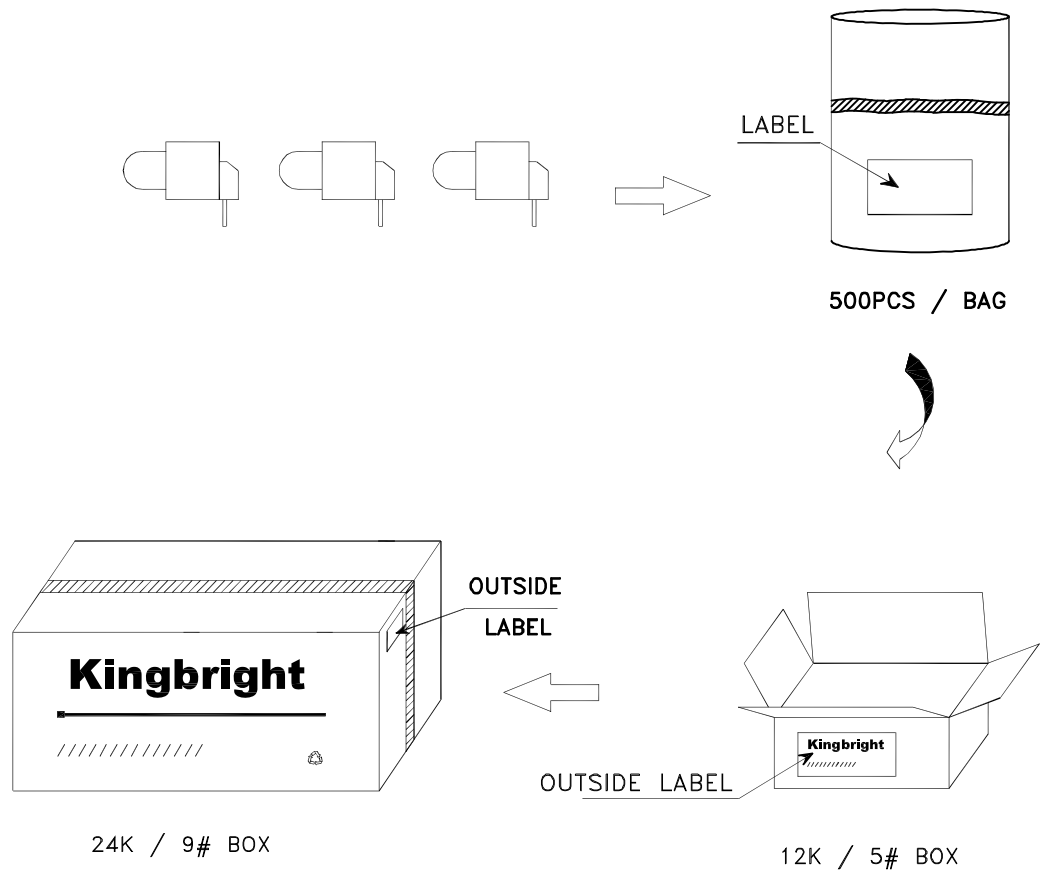



Yellow



PACKING & LABEL SPECIFICATIONS

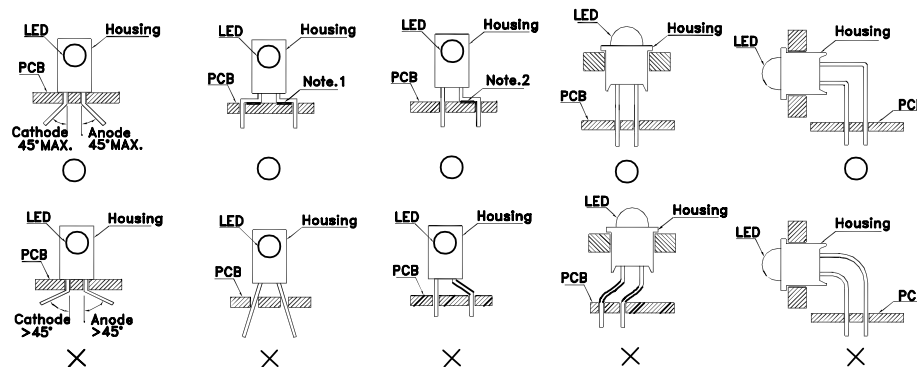
L-59CB/1EYW



Kingbright				
P/NO: L-59CBxxx				
QTY: 500 pcs	Q.C. <table border="1"><tr><td>Q C</td></tr><tr><td>xx xx xxxx</td></tr><tr><td>PASSED</td></tr></table>	Q C	xx xx xxxx	PASSED
Q C				
xx xx xxxx				
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S/N: XXXX				
CODE: XXX				
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RoHS Compliant				

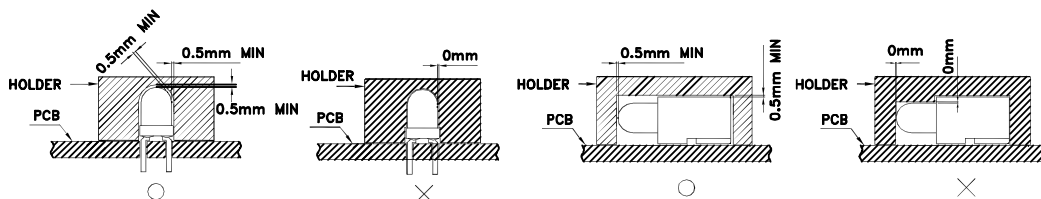
PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

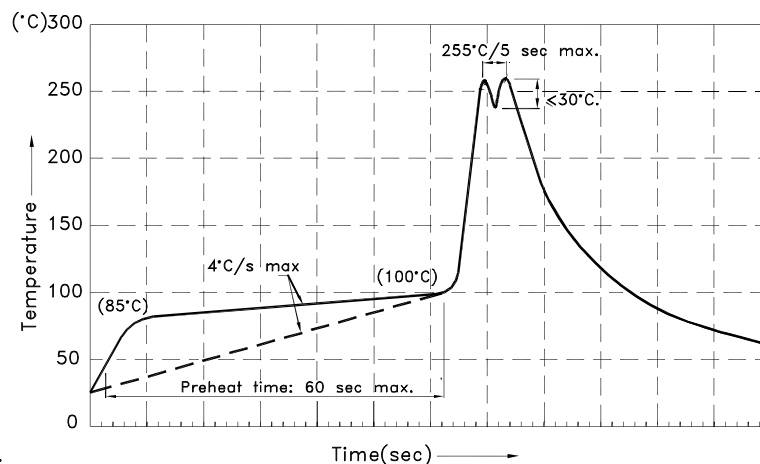


"O" Correct mounting method "X" Incorrect mounting method

2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



3. The tip of the soldering iron should never touch the lens epoxy.
4. Through-hole LEDs are incompatible with reflow soldering.
5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
6. Recommended Wave Soldering Profiles:



Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

Detailed application notes are listed on our website.

http://www.kingbright.com/application_notes